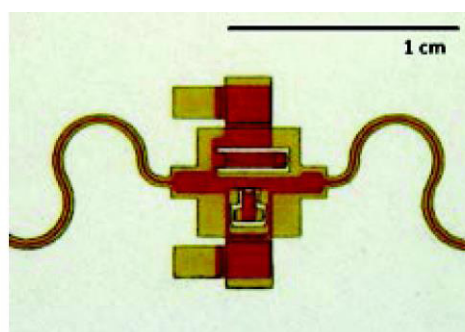
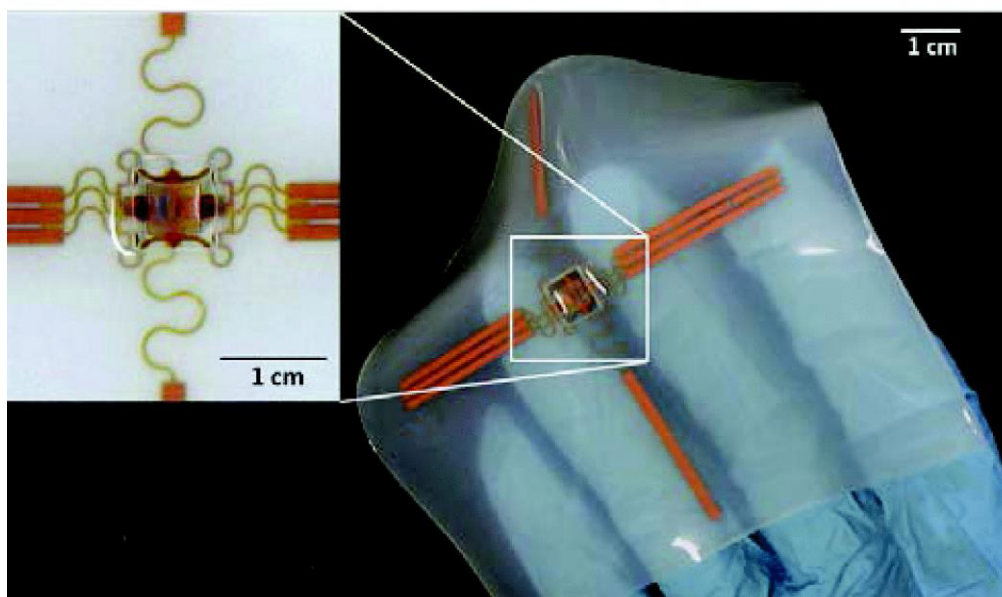


(a)



(b)



(c)

Sensor fabrication: (a) patterned top layer; (b) patterned bottom layer; and (c) complete sensor assembly with wiring pads (Vol. 17, No. 17, see page 5681).